

LP3943 16-Channel RGB, White-LED Driver with Independent SMBUS/I²C String Control

1 Features

- Internal power-on reset
- Active low reset
- Internal precision oscillator
- Variable dim rates (from 6.25ms to 1.6s; 160Hz to 0.625Hz)
- 16 LED drivers (multiple programmable states: ON, OFF, input, and dimming at a specified rate)
- 16 open-drain outputs capable of driving up to 25mA per LED

2 Applications

- Customized flashing LED lights for cellular phones
- Portable applications
- Digital cameras
- Indicator lamps
- General purpose I/O expander

3 Description

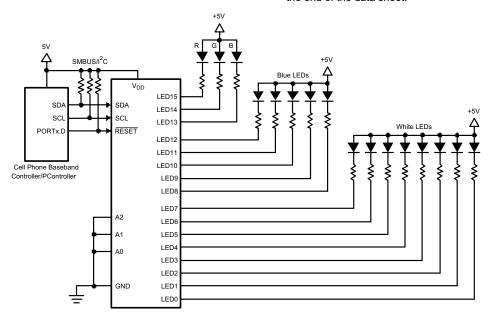
The LP3943 is an integrated device capable of independently driving 16 LEDs. This device also contains an internal precision oscillator that provides all the necessary timing required for driving each LED. Two prescaler registers, along with two PWM registers, provide a versatile duty-cycle control. The LP3943 contains the ability to dim LEDs in SMBUS/I²C applications where it is required, to cut down on bus traffic.

Traditionally, dimming LEDs using a serial shift register such as 74LS594/5 requires a large amount of traffic on the serial bus. The LP3943 instead requires only the setup of the frequency and duty cycle for each output pin; from then on, only a single command from the host is required to turn each individual open drain output to an ON or OFF state, or to cycle a programmed frequency and duty cycle. Maximum output sink current is 25mA per pin and 200mA per package. Any ports not used for controlling the LEDs can be used for general purpose input/output expansion.

Device Information (1)

| PART NUMBER | PACKAGE | BODY SIZE (NOM) |
|-------------|-----------|-----------------|
| LP3943 | WQFN (24) | 4.00mm × 4.00mm |

For all available packages, see the orderable addendum at the end of the data sheet.



Typical Application Circuit



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4 Pin Configuration and Functions

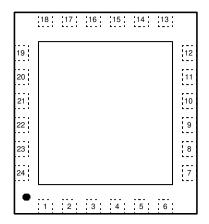


Figure 4-1. RTW Package 24-Pin WQFN With Exposed Pad Top View

Pin Functions

| PIN | | I/O | DESCRIPTION |
|--------|-------|--------|------------------------|
| NUMBER | NAME | 1/0 | DESCRIPTION |
| 1 | LED0 | Output | Output of LED0 Driver |
| 2 | LED1 | Output | Output of LED1 Driver |
| 3 | LED2 | Output | Output of LED2 Driver |
| 4 | LED3 | Output | Output of LED3 Driver |
| 5 | LED4 | Output | Output of LED4 Driver |
| 6 | LED5 | Output | Output of LED5 Driver |
| 7 | LED6 | Output | Output of LED6 Driver |
| 8 | LED7 | Output | Output of LED7 Driver |
| 9 | GND | Ground | Ground |
| 10 | LED8 | Output | Output of LED8 Driver |
| 11 | LED9 | Output | Output of LED9 Driver |
| 12 | LED10 | Output | Output of LED10 Driver |
| 13 | LED11 | Output | Output of LED11 Driver |

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| PIN | | I/O | DESCRIPTION |
|--------|-------------|--------------|-------------------------------------------------|
| NUMBER | NAME | 1/0 | DESCRIPTION |
| 14 | LED12 | Output | Output of LED12 Driver |
| 15 | LED13 | Output | Output of LED13 Driver |
| 16 | LED14 | Output | Output of LED14 Driver |
| 17 | LED15 | Output | Output of LED15 Driver |
| 18 | RST | Input | Active Low Reset Input |
| 19 | SCL | Input | Clock Line for I ² C Interface |
| 20 | SDA | Input/Output | Serial Data Line for I ² C Interface |
| 21 | VDD | Power | Power Supply |
| 22 | A0 | Input | Address Input 0 |
| 23 | A1 | Input | Address Input 1 |
| 24 | A2 | Input | Address Input 2 |
| _ | Exposed Pad | _ | Tie internally to GND pin. |



5 Specifications

5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1) (2) (3)

| | MIN | MAX | UNIT |
|--------------------------------------------------------------|-----------------------|-----|------|
| V_{DD} | -0.5 | 6 | V |
| A0, A1, A2, SCL, SDA, RST (Collectively called digital pins) | | 6 | V |
| Voltage on LED pins | V _{SS} - 0.5 | 6 | V |
| Junction temperature | | 150 | °C |
| Power dissipation ⁽⁴⁾ | | 400 | mW |
| Storage temperature | – 65 | 150 | °C |

⁽¹⁾ Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Section 5.3. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

5.2 ESD Ratings

| | | | VALUE | UNIT |
|--------------------------------------------|--------------------------------------------------------------------------------|-------------------------------------------------------------------|-------|------|
| | | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾ | ±2000 | |
| V _(ESD) Electrostatic discharge | Charged-device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾ | ±1000 | V | |
| | Machine model | ±200 | | |

⁽¹⁾ JEDEC document JEP155 states that 500V HBM allows safe manufacturing with a standard ESD control process.

5.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)(1) (2)

| | MIN | NOM MA | UNIT |
|-------------------------------|-----|--------|------|
| V_{DD} | 2.3 | 5. | 5 V |
| Junction temperature | -40 | 12 | 5 °C |
| Operating ambient temperature | -40 | 8 | °C |

⁽¹⁾ Absolute Maximum Ratings are limits beyond which damage to the device might occur. Recommended Operating Conditions are conditions under which operation of the device is ensured. Recommended Operating Conditions do not imply ensured performance limits. For verified performance limits and associated test conditions, see Section 5.5.

5.4 Thermal Information

| | THERMAL METRIC ⁽¹⁾ | RTW (WQFN) | UNIT |
|-----------------------|----------------------------------------------|------------|------|
| | | 24 PINS | |
| $R_{\theta JA}$ | Junction-to-ambient thermal resistance | 45.0 | °C/W |
| R _{0JC(top)} | Junction-to-case (top) thermal resistance | 41.5 | °C/W |
| $R_{\theta JB}$ | Junction-to-board thermal resistance | 22.4 | °C/W |
| ΨЈТ | Junction-to-top characterization parameter | 0.5 | °C/W |
| Ψ_{JB} | Junction-to-board characterization parameter | 22.5 | °C/W |

Product Folder Links: LP3943

⁽²⁾ All voltages are with respect to the potential at the GND pin.

⁽³⁾ If Military/Aerospace specified devices are required, contact the Texas Instruments Sales Office/ Distributors for availability and specifications.

⁽⁴⁾ The part cannot dissipate more than 400 mW.

⁽²⁾ JEDEC document JEP157 states that 250V CDM allows safe manufacturing with a standard ESD control process.

⁽²⁾ All voltages are with respect to the potential at the GND pin.



| THERMAL METRIC(1) | | RTW (WQFN) | UNIT |
|-----------------------|----------------------------------------------|------------|------|
| | | 24 PINS | |
| R _{0JC(bot)} | Junction-to-case (bottom) thermal resistance | 3.7 | °C/W |

⁽¹⁾ For more information about traditional and new thermal metrics, see Semiconductor and IC Package Thermal Metrics.



5.5 Electrical Characteristics

Unless otherwise noted, V_{DD} = 5.5V. Typical values and limits apply for T_J = 25°C. Minimum and maximum limits apply over the entire junction temperature range for operation, T_J = -40°C to +125°C. (1)

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-------------------------|-----------------------------------------|-----------------------------------------------------------------|--------------------|-----|--------------------|------|
| POWER SI | UPPLY | | | | | |
| V_{DD} | Supply voltage | | 2.3 | 5 | 5.5 | V |
| IQ | Supply current | No load | | 350 | 550 | |
| | | Standby | | 2 | 5 | μA |
| ΔI_Q | Additional standby current | V _{DD} = 5.5V, every LED pin at 4.3V | | | 2 | mA |
| V _{POR} | Power-On Reset voltage | | | 1.8 | 1.96 | V |
| t _w | Reset pulse width | | | 10 | | ns |
| LED | | | | | | |
| V_{IL} | Low level input voltage | | -0.5 | | 0.8 | V |
| V _{IH} | High level input voltage | | 2 | | 5.5 | V |
| | | V _{OL} = 0.4V, V _{DD} = 2.3V | 9 | | | |
| ı | | V _{OL} = 0.4V, V _{DD} = 3V | 12 | | | |
| l. | 1 and and antend an man 4(2) | V _{OL} = 0.4V, V _{DD} = 5V | 15 | | | mA |
| l _{OL} | Low level output current ⁽²⁾ | V _{OL} = 0.7V, V _{DD} = 2.3V | 15 | | | |
| ı | | V _{OL} = 0.7V, V _{DD} = 3V | 20 | | | |
| ı | | V _{OL} = 0.7V, V _{DD} = 5V | 25 | | | |
| I _{LEAK} | Input leakage current | V _{DD} = 3.6V, V _{IN} = 0V or V _{DD} | -1 | | 1 | μΑ |
| C _{I/O} | Input/output capacitance | See ⁽³⁾ | | 2.6 | 5 | pF |
| ALL DIGIT | AL PINS (EXCEPT SCL AND SDA | A PINS) | | | ' | |
| V _{IL} | LOW level input voltage | | -0.5 | | 0.8 | V |
| V _{IH} | HIGH level input voltage | | 2 | | 5.5 | V |
| I _{LEAK} | Input leakage current | | -1 | | 1 | μA |
| C _{IN} | Input capacitance | $V_{IN} = 0V^{(3)}$ | | 2.3 | 5 | pF |
| I ² C INTERI | FACE (SCL AND SDA PINS) | | | | ' | |
| V _{IL} | LOW level input voltage | | -0.5 | | 0.3V _{DD} | V |
| V _{IH} | HIGH level input voltage | | 0.7V _{DD} | | 5.5 | V |
| V _{OL} | LOW level output voltage | | 0 | | 0.2V _{DD} | V |
| I _{OL} | LOW level output current | V _{OL} = 0.4V | 3 | 6.5 | | mA |
| I _{Q_SCL/SDA} | SCL/SDA to VDD capable current | | | 100 | | μΑ |
| f_{CLK} | Clock frequency | | | | 400 | kHz |

⁽¹⁾ Limits are ensured. All electrical characteristics having room-temperature limits are tested during production with T_J = 25°C. All hot and cold limits are ensured by correlating the electrical characteristics to process and temperature variations and applying statistical process control.

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⁽²⁾ Each LED pin must not exceed 25 mA and each octal (LED0–LED7; LED8–LED15) must not exceed 100 mA. The package must not exceed a total of 200 mA.

⁽³⁾ Verified by design.

5.6 I²C Interface (SCL and SDA Pins) Timing Requirements

See⁽¹⁾

| | | MIN | NOM | MAX | UNIT |
|------------------------|--------------------------------------------------------------------------------------------------------|-----|-----|-----|------|
| t _{HOLD} | Hold time repeated START condition | 0.6 | | | μs |
| t _{CLK-LP} | CLK low period | 1.3 | | | μs |
| t _{CLK-HP} | CLK high period | 0.6 | | | μs |
| t _{SU} | Setup time repeated START condition | 0.6 | | | μs |
| t _{DATA-HOLD} | Data hold time | 300 | | | ns |
| t _{DATA-SU} | Data setup time | 100 | | | ns |
| t _{SU} | Setup time for STOP condition | 0.6 | | | μs |
| t _{TRANS} | Maximum pulse width of spikes that must be suppressed by the input filter of both DATA and CLK signals | | 50 | | ns |

⁽¹⁾ All values verified by design.

5.7 Typical Characteristic

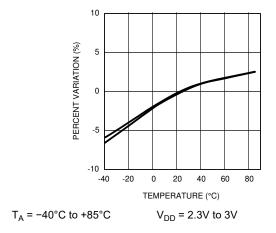


Figure 5-1. Frequency vs. Temperature



6 Detailed Description

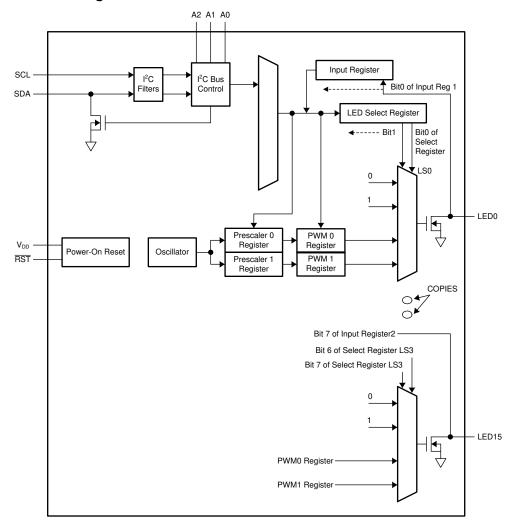
6.1 Overview

The LP3943 takes incoming data from the baseband controller and feeds them into several registers that control the frequency and the duty cycle of the LEDs. Two prescaler registers and two PWM registers provide two individual rates to dim or blink the LEDs (for more information on these registers, refer to Table 6-1). Each LED can be programmed in one of four states: ON, OFF, DIM0 rate, or DIM1 rate. Two read-only registers provide status on all 16 LEDs. The LP3943 can be used to drive RGB LEDs and/or single-color LEDs to create a colorful, entertaining, and informative setting. Alternatively, it can also drive RGB LED as a flashlight. This is particularly suitable for accessory functions in cellular phones and toys. Any LED pins not used to drive LED can be used for general purpose parallel input/output (GPIO) expansion.

The LP3943 is equipped with power-on reset that holds the chip in a reset state until V_{DD} reaches V_{POR} during power up. Once V_{POR} is achieved, the LP3943 comes out of reset and initializes itself to the default state.

To bring the LP3943 into reset, hold the \overline{RST} pin LOW for a period of TW. This puts the chip into its default state. The LP3943 can only be programmed after \overline{RST} signal is HIGH again.

6.2 Functional Block Diagram



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6.3 Feature Description

Some of the features of the LP3943 device are:

- 1. 16 low-side switches to control the current in 16 strings of LEDs with a maximum of 25mA per switch or a maximum of 200mA total.
- 2. Programmable internal PWM dimming:
 - a. Duty cycle control (8 bits). Any of the 16 current switches can be mapped to either PWM0 register or PWM1 register. Each register offers 8-bit PWM duty cycle control.
 - b. PWM Frequency control (8 bits). Any of the 16 current switches can be mapped to either PSC0 register or PSC1 register. Each register offers 8-bit PWM frequency control from 0.625Hz to 160Hz.
- 3. RESET input.
- 4. Auto increment for I2C writes to reduce number of I2C clock pulses .
- 5. The LP3943 provides for an externally selectable I2C slave address via the ADR0, ADR1, and ADR2 inputs. See Figure 6-3.

6.4 Device Functional Modes

- 1. Output set to high impedance. This is set by programming bits [B0 and B1] to 00 in the LS0, LS1, LS2, or LS3 registers (see Table 2)
- 2. Output set to ON state (current switch pulls low). This turns the LED on at the full current in the specified current switch bits [B0 and B1] set to 01 in the LS0, LS1, LS2, or LS3 registers (see Table 6-12).
- 3. Output set to toggle at the programmed PWM duty cycle and PWM frequency. This turns on or off the specified current switch at the programmed PWM frequency and duty cycle. Each current switch is mapped to either of the PWM0/PSC0 or PWM1/PSC1 pairs by setting [B0 and B1] to 10 or 11 in the LS0, LS1, LS2, or LS3 registers (see Table 6-12).

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6.5 Programming

6.5.1 I²C Data Validity

The data on SDA line must be stable during the HIGH period of the clock signal (SCL). In other words, state of the data line can only be changed when CLK is LOW.

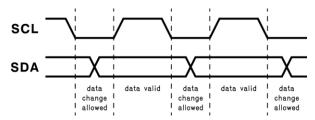


Figure 6-1. I²C Data Validity

6.5.2 I²C START and STOP Conditions

START and STOP bits classify the beginning and the end of the I²C session. START condition is defined as SDA signal transitioning from HIGH to LOW while SCL line is HIGH. STOP condition is defined as the SDA transitioning from LOW to HIGH while SCL is HIGH. The I²C master always generates START and STOP bits. The I²C bus is considered to be busy after START condition and free after STOP condition. During data transmission, I²C master can generate repeated START conditions. First START and repeated START conditions are equivalent, function-wise.

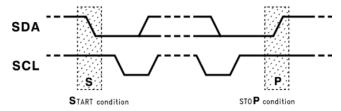


Figure 6-2. I²C START and STOP Conditions

6.5.3 Transferring Data

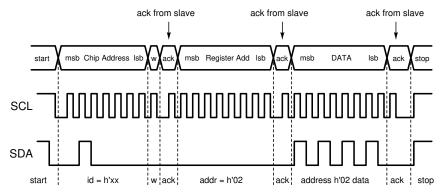
Every byte put on the SDA line must be eight bits long with the most significant bit (MSB) being transferred first. The number of bytes that can be transmitted per transfer is unrestricted. Each byte of data has to be followed by an acknowledge bit. The acknowledge related clock pulse is generated by the master. The transmitter releases the SDA line (HIGH) during the acknowledge clock pulse. The receiver must pull down the SDA line during the 9th clock pulse, signifying an acknowledge. A receiver which has been addressed must generate an acknowledge after each byte has been received.

After the START condition, a chip address is sent by the I²C master. This address is seven bits long followed by an eighth bit which is a data direction bit (R/W). The LP3943 hardwires bits 7 to 4 and leaves bits 3 to 1 selectable, as shown in Figure 6-3. For the eighth bit, a 0 indicates a WRITE and a 1 indicates a READ. The LP3943 supports only a WRITE during chip addressing. The second byte selects the register to which the data is written. The third byte contains data to write to the selected register.



Figure 6-3. Chip Address Byte

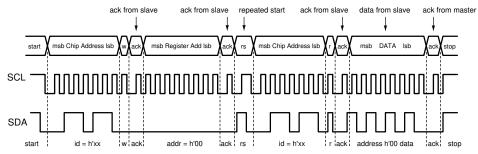
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w = write (SDA = 0) r = read (SDA = 1) ack = acknowledge (SDA pulled LOW by either master or slave) rs = repeated start xx = 60 to 67

Figure 6-4. LP3943 Register Write

However, if a READ function is to be accomplished, a WRITE function must precede the READ function, as shown in Figure 6-5.



w = write (SDA = "0") r = read (SDA = "1") ack = acknowledge (SDA pulled LOW by either master or slave) rs = repeated start xx = 60 to 67

Figure 6-5. LP3943 Register Read

6.5.4 Auto Increment

Auto increment is a special feature supported by the LP3943 to eliminate repeated chip and register addressing when data are to be written to or read from registers in sequential order. The auto increment bit is inside the register address byte, as shown in Figure 6-6. Auto increment is enabled when this bit is programmed to "1" and disabled when it is programmed to "0".

Bits 5, 6 and 7 in the register address byte must always be zero.

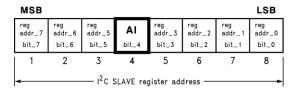


Figure 6-6. Register Address Byte

In the READ mode, when auto increment is enabled, I²C master could receive any number of bytes from LP3943 without selecting chip address and register address again. Every time the I²C master reads a register, the LP3943 increments the register address, and the next data register is read. When I²C master reaches the last register (09H), the register address rolls over to 00H.

In the WRITE mode, when auto increment is enabled, the LP3943 increments the register address every time I^2C master writes to register. When the last register (09H register) is reached, the register address rolls over to

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02H, not 00H, because the first two registers in LP3943 are read-only registers. It is possible to write to the first two registers independently, and the LP3943 device will acknowledge, but the data is ignored.

If auto increment is disabled, and the I^2C master does not change register address, it continues to write data into the same register.

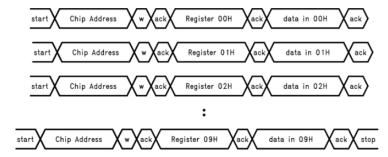


Figure 6-7. Programming With Auto Increment Disabled (in WRITE Mode)

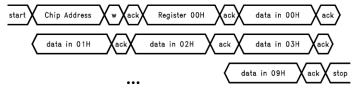


Figure 6-8. Programming With Auto Increment Enabled (in WRITE Mode)

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6.6 Register Maps

Table 6-1. LP3943 Register Table

| Address (Hex) | Register Name | Read/Write | Register Function |
|---------------|---------------|------------|------------------------|
| 0x00 | Input 1 | Read Only | LED0-7 Input Register |
| 0x01 | Input 2 | Read Only | LED8–15 Input Register |
| 0x02 | PSC0 | R/W | Frequency Prescaler 0 |
| 0x03 | PWM0 | R/W | PWM Register 0 |
| 0x04 | PSC1 | R/W | Frequency Prescaler 1 |
| 0x05 | PWM1 | R/W | PWM Register 1 |
| 0x06 | LS0 | R/W | LED0-3 Selector |
| 0x07 | LS1 | R/W | LED4–7 Selector |
| 0x08 | LS2 | R/W | LED8–11 Selector |
| 0x09 | LS3 | R/W | LED12–15 Selector |

6.6.1 Binary Format for Input Registers (Read-only)—Address 0x00 and 0x01

Table 6-2. Address 0x00

| Bit # | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
|-------------------------|------|------|------|------|------|------|------|------|--|
| Default value | X | Х | X | X | X | X | X | X | |
| | LED7 | LED6 | LED5 | LED4 | LED3 | LED2 | LED1 | LED0 | |
| Table 6-3. Address 0x01 | | | | | | | | | |

| lable | 0 -3. | Addi | ess | UXU | ı |
|-------|--------------|------|-----|-----|---|
| | | | | | |

| Bit # | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|-------|-------|-------|------|------|
| Default value | Х | Х | Х | Х | Х | Х | Х | Х |
| | LED15 | LED14 | LED13 | LED12 | LED11 | LED10 | LED9 | LED8 |

6.6.2 Binary Format for Frequency Prescaler and PWM Registers — Address 0x02 to 0x05

Table 6-4. Address 0x02 (PSC0)

| Bit # | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------------------|---|---|---|---|---|---|---|---|
| Default value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Table 6-5. Address 0x03 (PWM0) | | | | | | | | |

| Bit # | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|---|---|---|
| Default value | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Table 6-6. Address 0x04 (PSC1)

| Bit # | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|---|---|---|
| Default value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Table 6-7. Address 0x05 (PWM1)

| Bit # | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|---|---|---|
| Default value | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

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6.6.3 Binary Format for Selector Registers — Address 0x06 to 0x09

Table 6-8. Address 0x06 (LS0)

| Bit # | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|----|------|----|------|----|------|----|
| Default value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | B1 | В0 | B1 | В0 | B1 | В0 | B1 | В0 |
| | LED3 | | LED2 | | LED1 | | LED0 | |

Table 6-9. Address 0x07 (LS1)

| Bit # | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|----|----|----|----|----|----|----|----|
| Default value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | B1 | В0 | B1 | В0 | B1 | В0 | B1 | В0 |
| | LE | D7 | LE | D6 | LE | D5 | LE | D4 |

Table 6-10. Address 0x08 (LS2)

| Bit # | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|----|-----|----|-----|----|----|----|----|
| Default value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | B1 | В0 | B1 | В0 | B1 | В0 | B1 | В0 |
| | LE | D11 | LE | D10 | LE | D9 | LE | D8 |

Table 6-11. Address 0x09 (LS3)

| Bit # | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|----|-------|----|-----|-----|----|-----|
| Default value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | B1 | В0 | B1 | В0 | B1 | В0 | B1 | В0 |
| | LED15 | | LED14 | | LEI | D13 | LE | D12 |

Table 6-12. LED States With Respect To Values in B1 and B0

| B1 | В0 | Function |
|----|----|----------------------------|
| 0 | 0 | Output Hi-Z (LED off) |
| 0 | 1 | Output LOW (LED on) |
| 1 | 0 | Output dims (DIM0 rate) |
| 1 | 1 | Output dims (DIM1 rate) |

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Programming Example:

- Dim LEDs 0 to 7 at 1Hz at 25% duty cycle
- Dim LEDs 8 to 12 at 5Hz at 50% duty cycle
- Set LEDs 13, 14 and 15 off
- Step 1: Set PSC0 to achieve DIM0 of 1 s
- Step 2: Set PWM0 duty cycle to 25%
- Step 3: Set PSC1 to achieve DIM1 of 0.2 s
- Step 4: Set PWM1 duty cycle to 50%
- Step 5: Set LEDs 13, 14 and 15 off by loading the data into LS3 register
- Step 6: Set LEDs 0 to 7 to point to DIM0
- Step 7: Set LEDs 8 to 12 to point to DIM1

Table 6-13. Programming Details

| | Table 6-13. Flogramming Details | | | | | | | | | | |
|------|--------------------------------------------------------------|---------------|--------------------------|--|--|--|--|--|--|--|--|
| STEP | DESCRIPTION | REGISTER NAME | SET TO (HEX) | | | | | | | | |
| 1 | Set DIM0 = 1 s 1 = (PSC0 + 1)/160 PSC0 = 159 | PSC0 | 0x09F | | | | | | | | |
| 2 | Set duty cycle to 25% Duty Cycle = PWM0/256 PWM0 = 64 | PWM0 | 0x40 | | | | | | | | |
| 3 | Set DIM1 = 0.2s 0.2 = (PSC1 + 1)/160 PSC1 = 31 | PSC1 | 0x1F | | | | | | | | |
| 4 | Set duty cycle to 50% Duty Cycle = PWM1/256 PWM1 = 128 | PWM1 | 0x80 | | | | | | | | |
| 5 | LEDs 13, 14 and 15 off Output = HIGH | LS3 | 0x03 | | | | | | | | |
| 6 | LEDs 0 to 7 Output = DIM0 | LS0, LS1 | LS0 = 0xAA LS1 = 0xAA | | | | | | | | |
| 7 | LEDs 8 to 12 Output = DIM1 | LS2, LS3 | LS2 = 0xFF LS3 = 0x03 | | | | | | | | |

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Application and Implementation

Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

1 Application Information

The LP3943 is a 16-channel LED controller which has 16 low-side current switches. Each switch can control the LED current in its respective LED or LEDs by modulating its duty cycle and frequency.

2 Typical Application

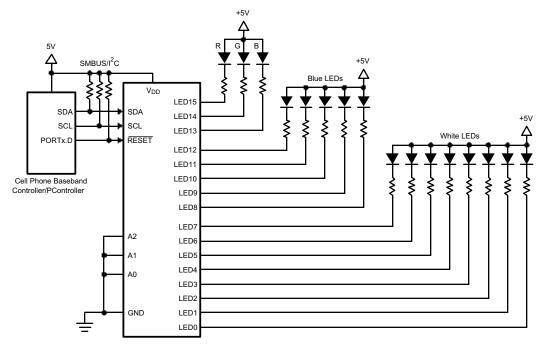


Figure 7-1. LP3943 Typical Application

2.1 Design Requirements

For typical RGB LED light-driver applications, use the parameters listed in Table 7-1.

Table 7-1. Design Parameters

| DESIGN PARAMETER | EXAMPLE VALUE | | | |
|------------------------|---------------|--|--|--|
| Minimum input voltage | 2.3 V | | | |
| Typical output voltage | 5 V | | | |
| Output current | 20 mA | | | |

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2.2 Detailed Design Procedure

2.2.1 Reducing Io When LEDs are OFF

In many applications, the LEDs and the LP3943 share the same V_{DD} , as shown in Figure 7-1. When the LEDs are off, the LED pins are at a lower potential than V_{DD} , causing extra supply current (ΔI_Q). To minimize this current, consider keeping the LED pins at a voltage equal to or greater than V_{DD} .

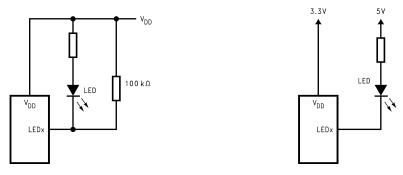


Figure 7-2. Methods to Reduce I_Q When LEDs are in OFF State

2.3 Application Curve

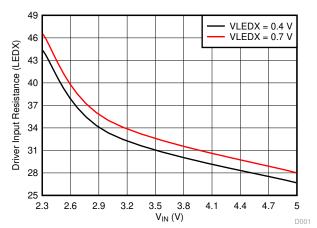


Figure 7-3. Typical LED Switch Resistance



3 System Examples

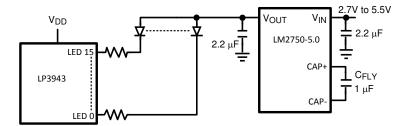


Figure 7-4. LP3943 With 5V Booster

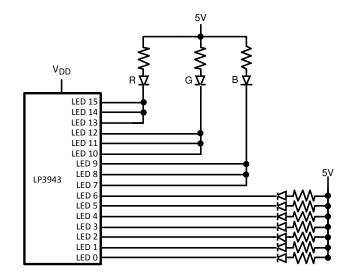


Figure 7-5. LP3943 Driving RGB LED as a Flash

4 Power Supply Recommendations

The LP3943 is designed to be powered from a 2.3V minimum to a 5.5V maximum supply input.

5 Layout

5.1 Layout Guidelines

The LP3943 layout is not critical, but TI recommends providing a noise-free supply input at V_{DD} . This typically would require a 1µF capacitor placed close to the VDD pin and ground.

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5.2 Layout Example

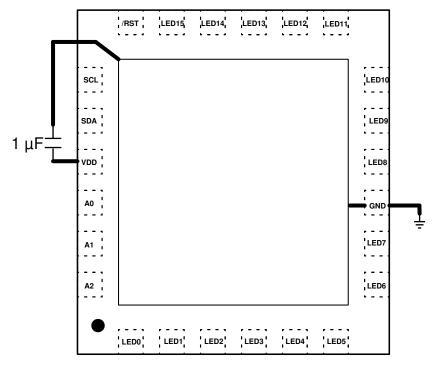


Figure 7-6. LP3943 Layout Example



7 Device and Documentation Support

7.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

7.2 Community Resources

7.3 Trademarks

All trademarks are the property of their respective owners.

8 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| С | hanges from Revision D (October 2016) to Revision E (October 2024) | Page |
|----------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|
| • | Added SCL/SDA to VDD capable current parameter to the Electrical Characteristics table | 4 |
| C | hanges from Revision C (October 2015) to Revision D (October 2016) | Page |
| • | Changed change wording of title to add SEO keywords | 1 |
| • | Changed R _{0,JA} value from "37°C/W" to "45.0°C/W"; add additional thermal values | |
| С | hanges from Revision B (September 2013) to Revision C (October 2015) | Page |
| С | hanges from Revision B (September 2013) to Revision C (October 2015) | Page |
| <u>C</u> | hanges from Revision B (September 2013) to Revision C (October 2015) Added Device Information and Pin Configuration and Functions sections, ESD Ratings table, Feature | Page |
| <u>C</u> | Added Device Information and Pin Configuration and Functions sections, ESD Ratings table, Feature Description, Device Functional Modes, Application and Implementation, Power Supply Recommendation | |
| <u>C</u> | Added Device Information and Pin Configuration and Functions sections, ESD Ratings table, Feature | ions, |
| <u>C</u> | Added Device Information and Pin Configuration and Functions sections, ESD Ratings table, Feature Description, Device Functional Modes, Application and Implementation, Power Supply Recommendation Layout, Device and Documentation Support, and Mechanical, Packaging, and Orderable Information | ions, |
| • | Added Device Information and Pin Configuration and Functions sections, ESD Ratings table, Feature Description, Device Functional Modes, Application and Implementation, Power Supply Recommendation Layout, Device and Documentation Support, and Mechanical, Packaging, and Orderable Information | ions, |

Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

Product Folder Links: LP3943

www.ti.com 8-Nov-2025

PACKAGING INFORMATION

| Orderable part number | Status | Material type | Package Pins | Package qty Carrier | RoHS | Lead finish/ | MSL rating/ | Op temp (°C) | Part marking |
|-----------------------|----------|---------------|-----------------|-----------------------|------|---------------|--------------------|--------------|--------------|
| | (1) | (2) | | | (3) | Ball material | Peak reflow | | (6) |
| | | | | | | (4) | (5) | | |
| LP3943ISQ | Obsolete | Production | WQFN (RTW) 24 | - | - | Call TI | Call TI | -40 to 85 | 3943SQ |
| LP3943ISQ/NOPB | Active | Production | WQFN (RTW) 24 | 1000 SMALL T&R | Yes | SN | Level-1-260C-UNLIM | -40 to 85 | 3943SQ |
| LP3943ISQ/NOPB.A | Active | Production | WQFN (RTW) 24 | 1000 SMALL T&R | Yes | SN | Level-1-260C-UNLIM | -40 to 85 | 3943SQ |
| LP3943ISQX/NOPB | Active | Production | WQFN (RTW) 24 | 4500 LARGE T&R | Yes | SN | Level-1-260C-UNLIM | -40 to 85 | 3943SQ |
| LP3943ISQX/NOPB.A | Active | Production | WQFN (RTW) 24 | 4500 LARGE T&R | Yes | SN | Level-1-260C-UNLIM | -40 to 85 | 3943SQ |

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE MATERIALS INFORMATION

www.ti.com 31-Jul-2025

TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width |
|----|-----------------------------------------------------------|
| В0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| | Device | Package Type | Package Drawing | | | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------|-------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| LP39 | 43ISQ/NOPB | WQFN | RTW | 24 | 1000 | 177.8 | 12.4 | 4.3 | 4.3 | 1.3 | 8.0 | 12.0 | Q1 |
| LP394 | 13ISQX/NOPB | WQFN | RTW | 24 | 4500 | 330.0 | 12.4 | 4.3 | 4.3 | 1.3 | 8.0 | 12.0 | Q1 |

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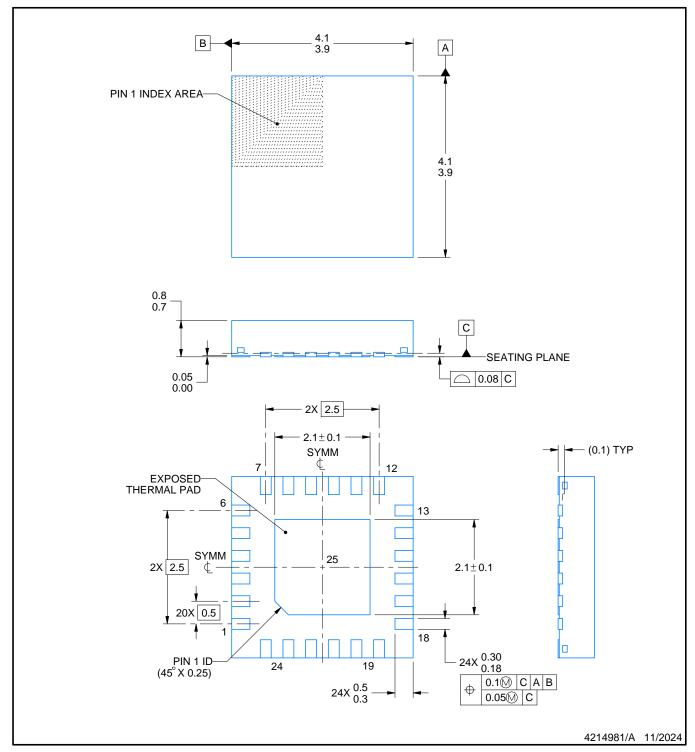


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LP3943ISQ/NOPB | WQFN | RTW | 24 | 1000 | 208.0 | 191.0 | 35.0 |
| LP3943ISQX/NOPB | WQFN | RTW | 24 | 4500 | 367.0 | 367.0 | 35.0 |



PLASTIC QUAD FLATPACK - NO LEAD

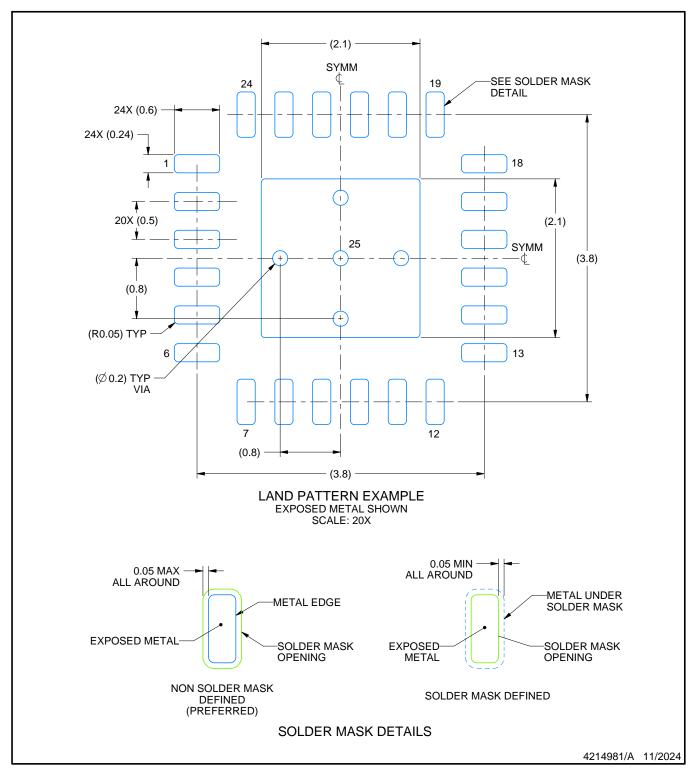


NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



PLASTIC QUAD FLATPACK - NO LEAD

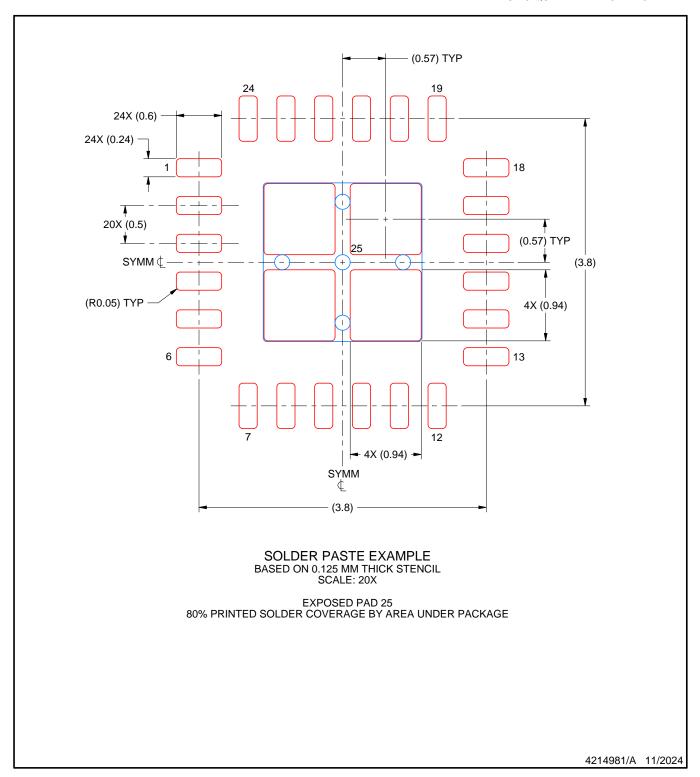


NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- 5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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